

# **Schottky Barrier Recitifier**

## **PRODUCT SUMMARY**

TO-220 Plastic-Encapsulate Transistors

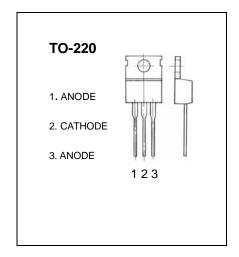
#### **FEATURES**

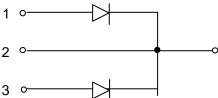
Scottky Barrier Chip Guard Ring Die Construction for Transient Protection Low Power Loss, High Efficiency Very low forward voltage drop High Surge Capability High Current Capability and Low Forward Voltage Drop For use in low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications



### **ELECTRICAL CHARACTERISTICS**

( Tamb = 25°C unless otherwise specified )





Characteristic	Symbol	MBR 1030CT	MBR 1035CT	MBR 1040CT	MBR 1045CT	MBR 1050CT	MBR 1060CT	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$							
Working Peak Reverse Voltage	$V_{RWM}$	30	35	40	45	50	60	V
DC Blocking Voltage	$V_R$							
PMS Reverse Voltage	V <sub>R(RMS)</sub>	21	24.5	28	31.5	35	42	V
Average Rectified Output Current (Note 1) @ T <sub>C</sub> =105°C	Io	10						А
Non-Repetitive Peak Forward Surge Current		I <sub>FSM</sub> 125						Α
8.3ms Single half sine-wave superimposed o	n I <sub>FSM</sub>							
rated load (JEDEC Method)								
Repetitive Peak Reverse Surge Current	I <sub>RRM</sub>	1.0						Α
@ t≤ 2.0μs	·KKW							,,
Forward Voltage Drop @ I <sub>F</sub> =5.0A, T <sub>C</sub> =125°		0.57				0.70		
@ I <sub>F</sub> =5.0A, T <sub>C</sub> = 25℃	V <sub>FM</sub>	0.70 0.80					80	V
@ I <sub>F</sub> =10A, T <sub>C</sub> = 25℃		0.84				0.95		
Peak Reverse Current @ T <sub>C</sub> = 25°C	l	I <sub>RM</sub> 0.1 15						mA
at Rated DC Blocking Voltage @ T <sub>C</sub> =125°	C KM							
Typical Junction Capacitance (Note 2)	C <sub>j</sub>	150					pF	
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>STG</sub>	-65 to +150					$^{\circ}$	

Notes: 1. Thermal resistance junction to case mounted heat sink.

2. Measured at 1.OMHz and applied reverse voltage of 4.0V DC.



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